ONSEMÍ,

<u>MOSFET</u> – N-Channel, SUPERFET[®] II

800 V, 14 A, 400 m Ω

FCPF400N80Z

Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2 kV HBM surge stress. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.

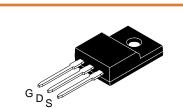
Features

- Typ. $R_{DS(on)} = 340 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 43 \text{ nC}$)
- Low E_{oss} (Typ. 4.1 µJ @ 400 V)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 138 pF)
- 100% Avalanche Tested
- ESD Improved Capability
- RoHS Compliant

Applications

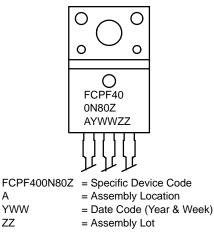
- AC–DC Power Supply
- LED Lighting

V _{DSS}	R _{DS(on)} MAX	I _D MAX	
800 V	400 mΩ @ 10 V	14 A	

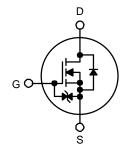


TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT





N-CHANNEL MOSFET



ORDERING INFORMATION

Part Number	Package	Shipping
FCPF400N80Z	TO-220F	1000 Units / Tube

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Symbol	Parameter		FCPF400N80Z	Unit
V _{DSS}	Drain to Source Voltage		800	
V _{GSS}	Gate to Source Voltage	– DC	±20	V
		– AC (f > 1 Hz)	±30	1
Ι _D	Drain Current	– Continuous (T _C = 25°C)	14*	Α
		– Continuous ($T_C = 100^{\circ}C$)	8.9*	1
I _{DM}	Drain Current	– Pulsed (Note 1)	33*	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		339	mJ
I _{AR}	Avalanche Current (Note 1)		2.2	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		0.36	mJ
dv/dt	MOSFET dv/dt 10		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
PD	Power Dissipation	(T _C = 25°C)	35.7	W
		– Derate Above 25°C	0.29	W/∘C
TJ, T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$, unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature, with heatsink.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 2.2 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 14 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le \text{BV}_{DSS}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

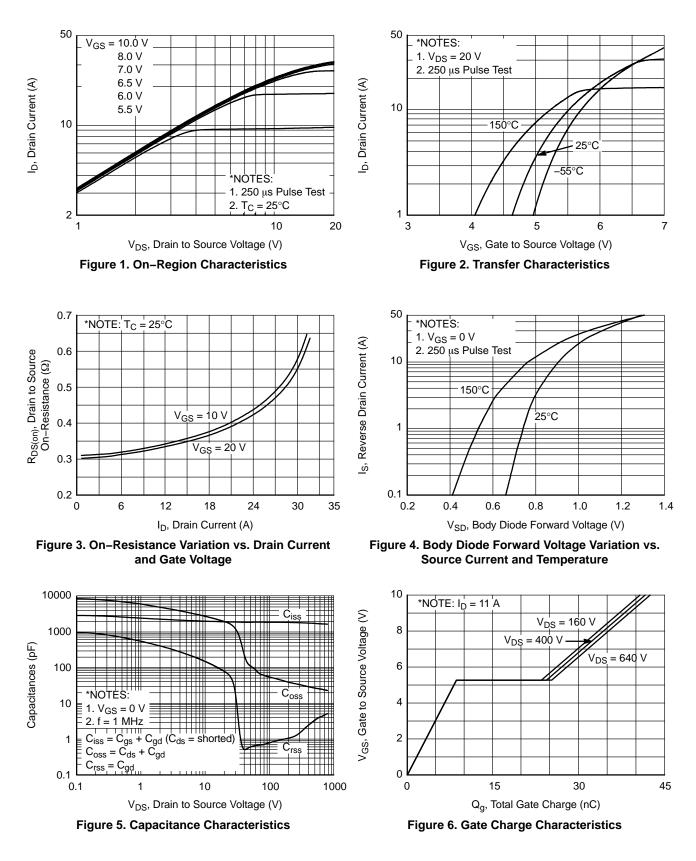
Symbol	Parameter	FCPF400N80Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•			•	
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ mA}, \text{ T}_{J} = 25^{\circ}\text{C}$	800	-	-	V
${\Delta {\rm BV}_{\rm DSS} \over \Delta {\rm T}_{\rm J}}/$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}$, Referenced to 25°C	-	0.8	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$	_	-	25	μΑ
		$V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	_	-	250	1
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	-	±10	μΑ
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 1.1 \text{ mA}$	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$	-	0.34	0.4	Ω
9FS	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$	_	12	-	S
DYNAMIC C	CHARACTERISTICS	••				
C _{iss}	Input Capacitance	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	1770	2350	pF
C _{oss}	Output Capacitance		_	51	70	pF
C _{rss}	Reverse Transfer Capacitance		_	0.5	-	pF
Coss	Output Capacitance	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	28	-	pF
Coss(eff.)	Effective Output Capacitance	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$	-	138	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 640 V, I _D = 11 A, V _{GS} = 10 V (Note 4)	-	43	56	nC
Q _{gs}	Gate to Source Gate Charge		-	8.6	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	17	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	2.3	-	Ω
SWITCHING	G CHARACTERISTICS	•			•	
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 11 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	20	50	ns
t _r	Turn–On Rise Time	R _g = 4.7 Ω (Note 4)	-	12	34	ns
t _{d(off)}	Turn-Off Delay Time		-	51	112	ns
t _f	Turn–Off Fall Time		-	2.6	15	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS	••				
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	14	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		_	-	33	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 11 A	_	-	1.2	V
t _{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 11 A, dI_F/dt = 100 A/µs	_	395	-	ns
Q _{rr}	Reverse Recovery Charge	1 h		7.4	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS



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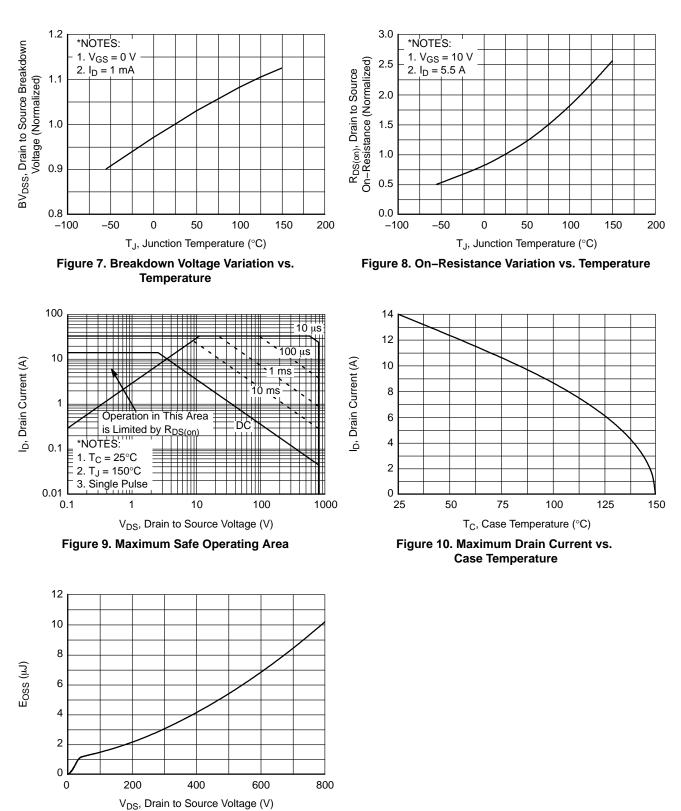


Figure 11. EOSS vs. Drain to Source Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

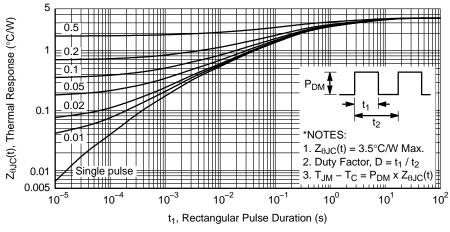
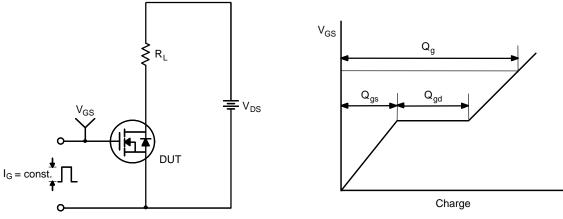


Figure 12. Transient Thermal Response Curve





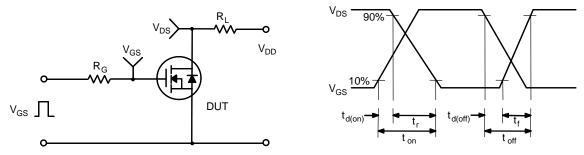
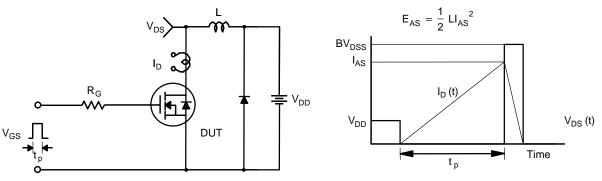


Figure 14. Resistive Switching Test Circuit & Waveforms





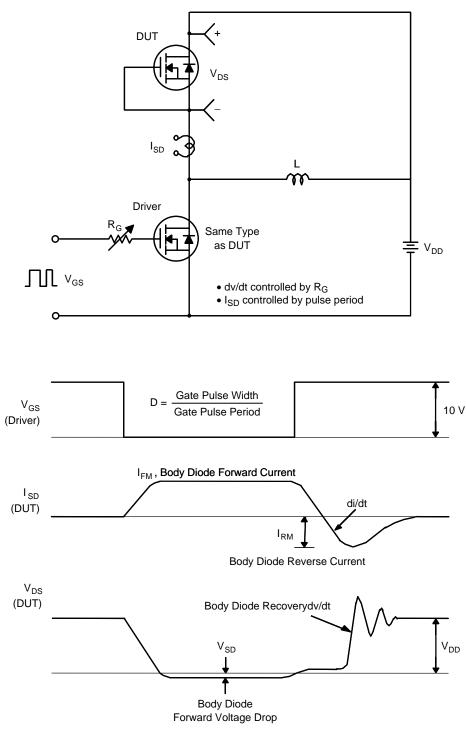


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT **ISSUE B** DATE 19 JAN 2021 Scale 1:1 E A ØΡ A2 \oplus \bigcirc Q H1 \oplus \oplus D А D1 * 1 L1 A1 b2 MILLIMITERS L DIM b MIN NDM MAX 4.50 4.70 4.90 A 2.56 2.76 2.96 A1 A2 2.34 2.54 2.74 1 2 3 0.90 С b 0.70 0.80 b2 ~ ~ 1.47 0.50 0.45 0.60 (F С OPTION1) D 15.67 15.87 16.07 DETAIL-A D1 15.60 15.80 16.00 E 9.96 10.16 10.36 пh <u>п†п</u> 2.54 2.34 2.74 е ØP1 F ~ 0.84 ~ H1 6.48 6.68 6.88 е е 12,78 12.98 13.18 L 3.43 L1 3.03 3.23 φP 2.98 3.18 3.38 Ø P1 1.00 ~ ~ Q 3.20 3.40 3.30 NOTES: A. DIMENSION AND TOLERANCE AS ASME Y14.5-2009

- B. DIMENSION AND TOLERANCE AS ASME 114.3-2009 B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUCSIONS.
- C. OPTION 1 WITH SUPPORT PIN HOLE

OPTION 2 - NO SUPPORT PIN HOLE

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DESCRIPTION:	TO-220 FULLPACK, 3-LEA	PAGE 1 OF 1			

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